

## **DRF12XX Evaluation Board**

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Figure 1 shows a simplified circuit diagram for the DRF12XX series of devices. The Hybrid consists of a MOSFET Driver and Power MOSFET. The control signal is applied to internal driver through pin 4 (IN) and referenced to pin 5 (GND) a Ground return. The pin 3 (FN) allows the user to select either Invert or Non-inverting mode. The output of the driver is internally applied to the gate of the Power MOSFET. The logic diagram for the hybrid is shown in Table 1. For more information on the specific DRF12XX, refer to the device data sheet.

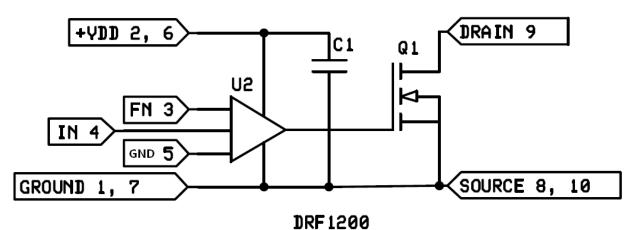


Figure 1. DRF12XX

FN (pin 3) Invert/Non-invert	IN (pin 4) Control	MOSFET	Function
High	High	On	Non-Invert.
High	Low	Off	Non-Invert.
Low	High	Off	Inverting
Low	Low	On	Inverting

Table 1

The DRF12XX Evaluation Board allows the design engineer to prototype a circuit of choice. It is initially configured as shown in Figure 2 allowing the user to evaluate the simple switching performance of the DRF12XX. The  $50\Omega$  load resistor (RL) has a power limit of 4 Watts. In this configuration, the DRF12XX Evaluation Board should be operated at a reduced Duty Cycle to avoid damaging the RL. The DRF12XX must be attached to a heat sink when reconfigured for dissipation greater than 4 watts.

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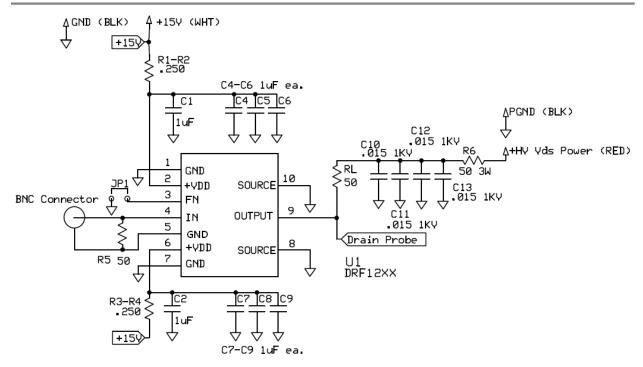


Figure 2. DRF12XX Evaluation Board

A 5V max signal input is applied to (IN) via the BNC connector. Using the Power Ground (GND) for the BNC shielding provides a ground connection for the input increasing noise immunity. Pins 2 and 6 (+VDD) are both connected on evaluation board and are also connected internally to help balance pulse currents in the hybrid. Pin 3 (FN) is the invert or non-invert select Pin, internally held high (non-inverting) and must be jumpered on the evaluation board (JP1) to ground to select the inverting mode.

Inputs	Parameter	Remarks
GND	Driver Ground	
+15V	Driver supply	CMC suggested
IN	+5V max signal	50Ω coax, CMC suggested
GND	(IN) Signal Rtn.	50Ω coax, Rtn, CMC suggested
Drain Probe	X100 Probe	Tek P5100, CMC suggested on probe lead
VDS	+1000V Max	CMC suggested
P GND	Power GND	Connected to MOSFET Source

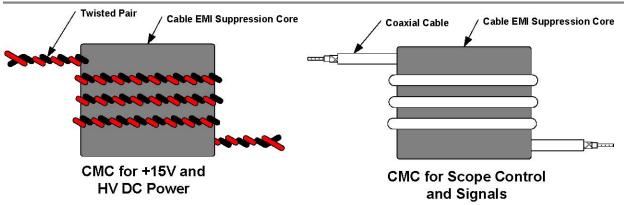
Table 2

Table 2 shows Evaluation board inputs and outputs and the highly recommended Common Mode Chokes (CMC) that should be used for the test bench set-up. This approach provides the best stability and the most accurate measurements.

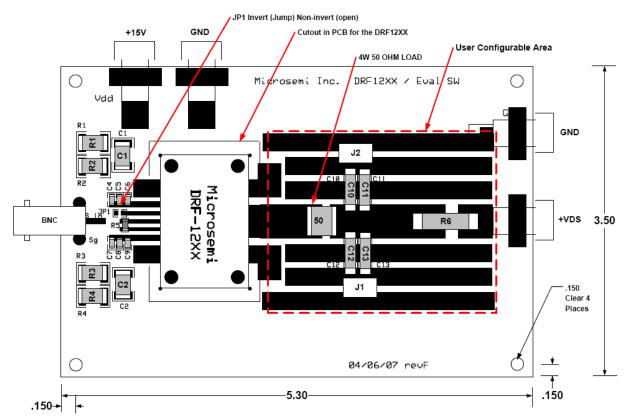
Construction of the CMCs are illustrated in Figure 3. The CMC on the left should be used for both the +15V input and the +HV VDS input. These lines are tightly twisted pairs (5-8 twists per inch). The CMC on the right should be used for the control signal Input and on the Scope Probe Cable. Three to five turns on each is sufficient. The CMCs should be placed as close to the DRF12XX Evaluation Board as practical.

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**Figure 3.** Common Mode Choke (CMC) FairRite part number 0431164181



**Figure 4.** DRF12XX Evaluation Board All Dimensions are  $\pm$  0.010 In. Max.

The DRF12XX evaluation board is initially configured as shown mechanically in Figure 4. The main purpose of the board is to verify SWITCHING PERFORMANCE for DRF12xx devices.

Mounting Instructions for Flangeless Devices: Refer to Application Note 1810 "DRF Device Mounting Procedures And Power Dissipation".